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Terms	Documents
L9	0

Database:

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US Pre-Grant Publication Full-Text Database
JPO Abstracts Database
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Derwent World Patents Index
IBM Technical Disclosure Bulletins

Search:

L10

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Set Name Query

side by side

*DB=TDBD; PLUR=YES; OP=OR*L10 L9*DB=DWPI; PLUR=YES; OP=OR*L9 L8*DB=EPAB; PLUR=YES; OP=OR*L8 L7*DB=JPAB; PLUR=YES; OP=OR*L7 L6*DB=PGPB; PLUR=YES; OP=OR*L6 L5*DB=USPT; PLUR=YES; OP=OR*L5 L4 and hydrophobicL4 (interconnect or wir\$4) near10 "foamed polymer"L3 (interconnect or wir\$4) near10 foamedL2 L1 and foamedL1 5747880**Hit Count Set Name**

result set

0 L100 L90 L80 L70 L60 L514 L4630 L31 L214 L1

END OF SEARCH HISTORY